Silicon N Channel Dual Gate MOS FET UHF / VHF RF Amplifier

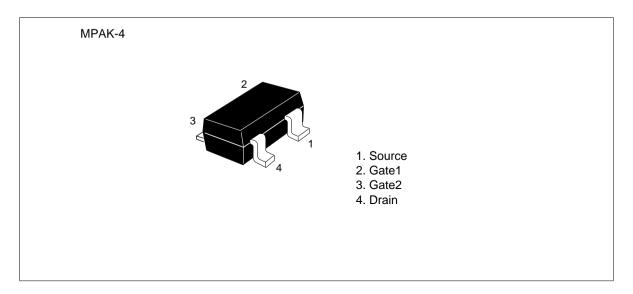
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ADE-208-449 1st. Edition

Features

- Low noise figure NF = 1.0 dB typ. at f = 200 MHz
- High gain PG = 27.6 dB typ. at f = 200 MHz

Outline





Absolute Maximum Ratings (Ta = 25° C)

Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DS}	14	V	
Gate 1 to source voltage	V _{G1S}	±8	V	
Gate 2 to source voltage	V _{G2S}	±8	V	
Drain current	I _D	25	mA	
Channel power dissipation	Pch	150	mW	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

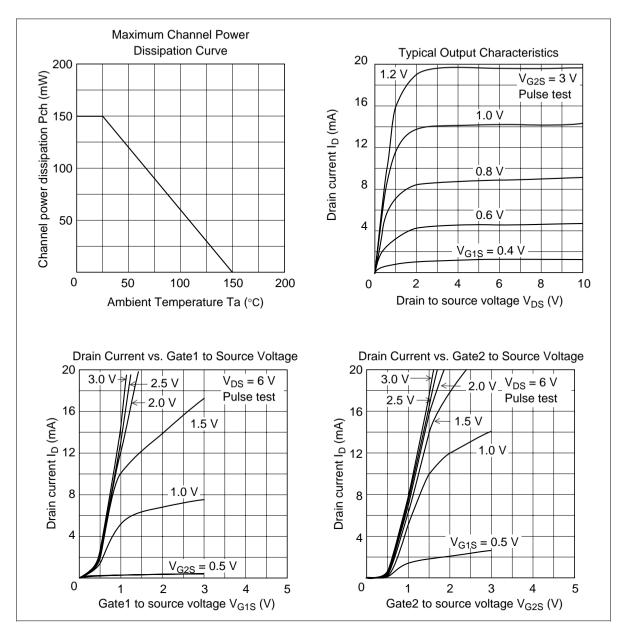
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Electrical Characteristics (Ta = 25°C)

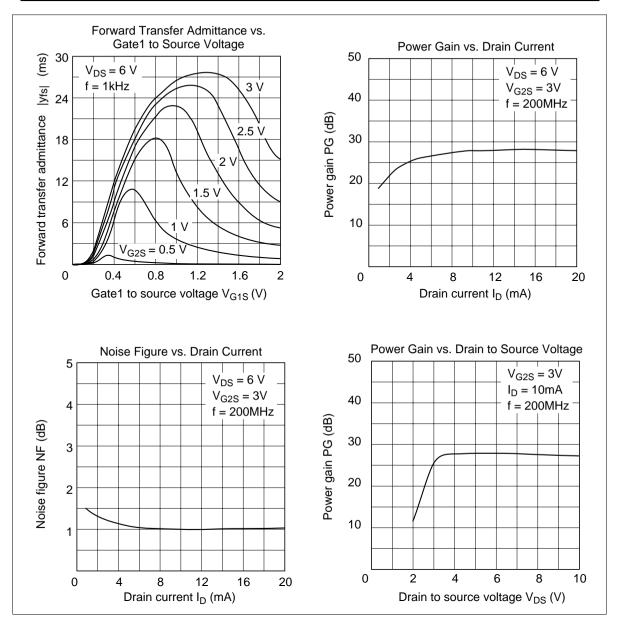
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSX}}$	14	_	_	V	$ I_{\rm D} = 200 \ \mu \text{A}, \ V_{\rm G1S} = -3 \ \text{V}, \\ V_{\rm G2S} = -3 \ \text{V} $
Gate 1 to source breakdown voltage	$V_{(\text{BR})\text{G1SS}}$	±8	_	_	V	$ I_{\rm G1} = \pm 10 \ \mu A, \\ V_{\rm DS} = V_{\rm G2S} = 0 $
Gate 2 to source breakdown voltage	$V_{(BR)G2SS}$	±8	_	_	V	$ I_{\rm G2} = \pm 10 \ \mu A, \\ V_{\rm DS} = V_{\rm G1S} = 0 $
Gate 1 cutoff current	I _{G1SS}	—	_	±100	nA	$\begin{array}{l} V_{\text{G1S}} = \pm 6 \ V, \\ V_{\text{DS}} = V_{\text{G2S}} = 0 \end{array} \end{array} \label{eq:VG1S}$
Gate 2 cutoff current	I _{G2SS}	_	_	±100	nA	$\begin{array}{l} V_{\text{G2S}} = \pm 6 \ V, \\ V_{\text{DS}} = V_{\text{G1S}} = 0 \end{array} \end{array} \label{eq:gamma}$
Drain current	I _{DS(op)}	4	8	14	mA	$V_{_{DS}} = 6 \text{ V}, V_{_{G1S}} = 0.75 \text{ V}, V_{_{G2S}} = 3 \text{ V}$
Gate 1 to source cutoff voltage	$V_{\rm G1S(off)}$	0	+0.2	+1.0	V	
Gate 2 to source cutoff voltage	$V_{\text{G2S(off)}}$	0	+0.3	+1.0	V	
Forward transfer admittance	y _{fs}	20	25	_	ms	$V_{DS} = 6 V, V_{G2S} = 3 V,$ $I_{D} = 10 mA, f = 1 kHz$
Input capacitance	Ciss	2.4	3.1	3.5	pF	V _{DS} = 6 V,
Output capacitance	Coss	0.8	1.1	1.4	pF	V _{G2S} = 3 V, I _D = 10 mA
Reverse transfer capacitance	Crss	_	0.021	0.04	pF	f = 1 MHz
Power gain	PG	24	27.6	_	dB	$V_{DS} = 6 V, V_{G2S} = 3 V,$
Noise figure	NF	_	1.0	1.5	dB	I _D = 10 mA, f = 200 MHz
Power gain	PG	12	15.6	_	dB	$V_{DS} = 6 V, V_{G2S} = 3 V,$
Noise figure	NF	_	3.0	4.0	dB	I _D = 10 mA, f = 900 MHz
Noise figure	NF	_	2.7	3.5	dB	$V_{DS} = 6 V, V_{G2S} = 3 V,$ $I_{D} = 10 mA, f = 60 MHz$

Note: Marking is "ZR-"

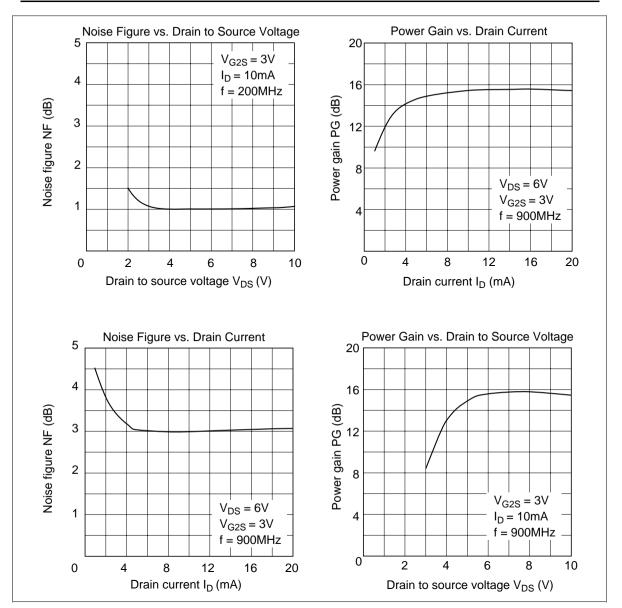
Main Characteristics

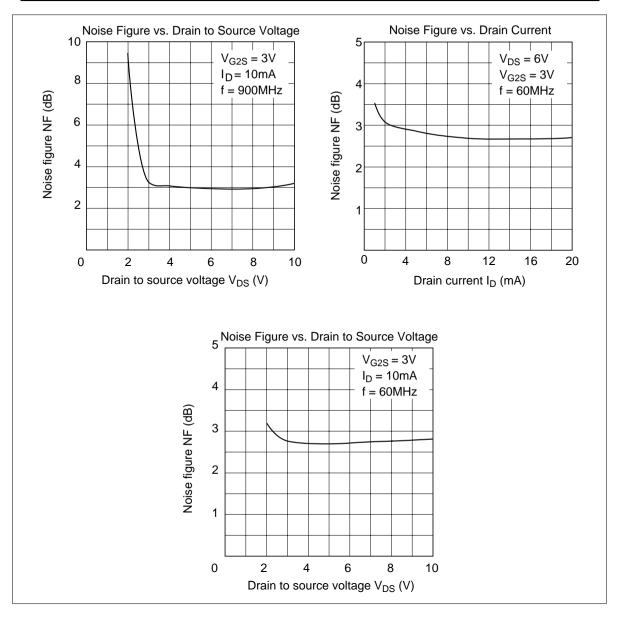


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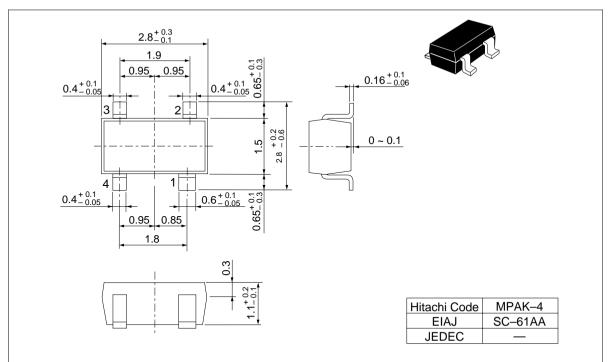
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Package Dimentions

Unit: mm



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